imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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LNJ814K8SRA

Surface Mounting Chip LED

USS Type

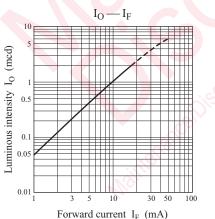
Absolute Maximum Ratings $T_a = 25^{\circ}C$

Absolute Maximum Ratings $I_a = 2$.	🔳 Ligi			
Parameter	Symbol	Rating	Unit	• Soft
Power dissipation	P _D	40	mW	
orward current	I _F	15	mA	
ulse forward current *	I _{FP}	50	mA	
Reverse voltage	V _R	3	v	
Deprating ambient temperature	T _{opr}	-30 to +85	°C	
torage temperature	T _{stg}	-40 to +100	°C	
ote) *: The condition of I_{FP} is duty 10%, Pulse	width 1 mse	ec.		
Electro-Optical Characteristics T _a =	= 25°C±3°	С		

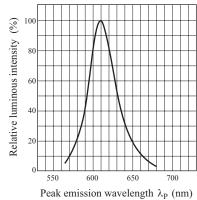
Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol		Conditions	Min	Тур	Max	Unit
Luminous intensity *	I _O	$I_F = 10 \text{ mA}$	0,00	0.5	1.0		mcd
Reverse current	I _R	$V_R = 4 V$				10	μΑ
Forward voltage	V _F	$I_{\rm F} = 10 {\rm mA}$	30, 10,		1.93	2.6	V
Peak emission wavelength	λ_{P}	$I_F = 10 \text{ mA}$	MILL CHI	2	610	, illo	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	Colling and the second	SO .	40		nm

Note) *: Measurement tolerance: ±20%



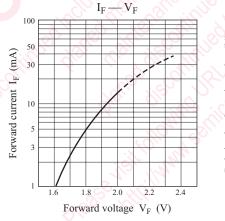
Relative luminous intensity — λ_P

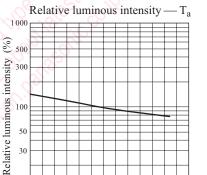


60

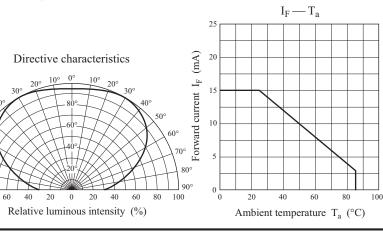
80

90° 100 80





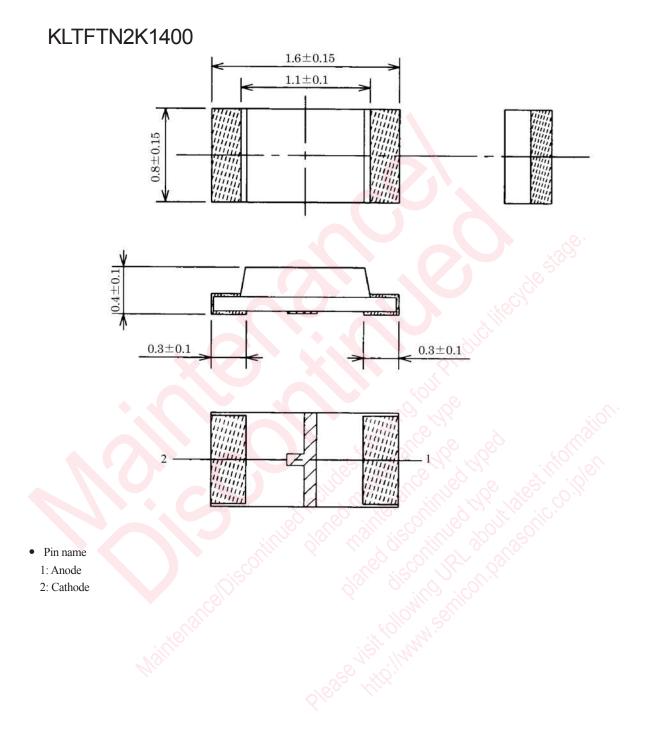
-20 0 20 40 60 80 Ambient temperature T_a (°C)



10

100

Package (Unit: mm)



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